

# Silicon Detectors for High Luminosity Colliders

**RD50 Status Report** 

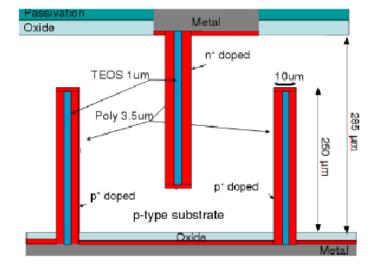
**Ulrich Parzefall** 

**University of Freiburg** 

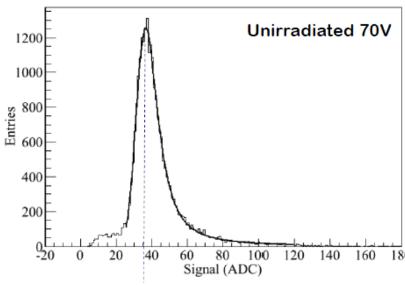
- On Behalf of the RD50 Collaboration -

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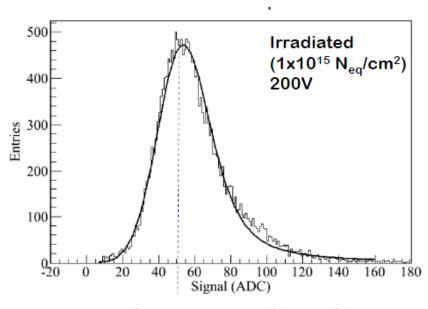
## Charge Collection – 3d Detectors



- Double Sided 3d p-type sensors (made by CNM) in SPS testbeam
- Irradiation at Karlsruhe KIT cyclotron with 26MeV protons
- Higher signal after irradiation than before
  - Charge multiplication



Landau MPV: 35 ADC



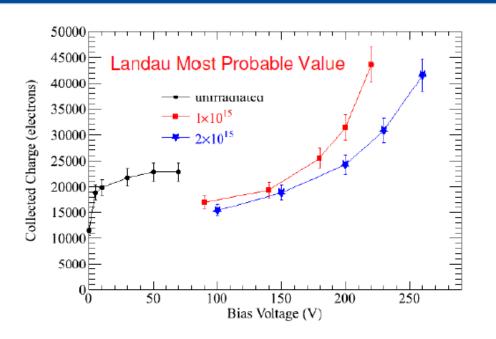
Landau MPV: 49 ADC

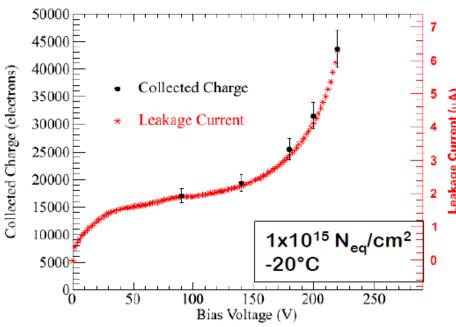
[M.Koehler et al., RD50 Workshop, May/June 2010]

# **Charge Collection – 3d Detectors**



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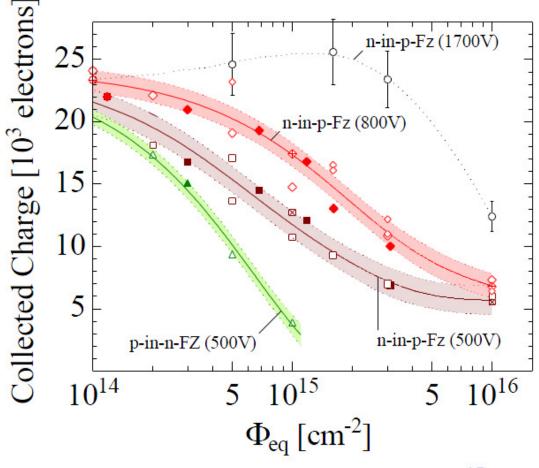


- All charge is multiplied (also thermally generated charge)
- Origin: avalanche multiplication in high-field region close to junction columns
- P-type detector: e<sup>-</sup> drifting near columns get multiplied
  - Effect has also been observed on similar n-type 3D DDTC, but to lesser extent
  - Holes seem to not multiply so easily (due to 3x lower mobility ?)
- Charge multiplication also in irradiated planar p-type detectors, but for higher V<sub>bias</sub>
- High field in 3D detectors facilitates charged multiplication compared to planar designs

# Planar Detector Compilation

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#### FZ Silicon Strip Sensors

- n-in-p (FZ), 300µm, 500V, 23GeV p
- □ n-in-p (FZ), 300µm, 500V, neutrons
- n-in-p (FZ), 300µm, 500V, 26MeV p
- n-in-p (FZ), 300µm, 800V, 23GeV p
- on-in-p (FZ), 300μm, 800V, neutrons
- n-in-p (FZ), 300μm, 800V, 26MeV p
- o n-in-p (FZ), 300µm, 1700V, neutrons
- p-in-n (FZ), 300μm, 500V, 23GeV p
- Δ p-in-n (FZ), 300μm, 500V, neutrons

RD50 - M. Moll

- p-in-n fades away well before 10<sup>15</sup>N<sub>eq</sub>/cm<sup>2</sup>
- n-in-p still gets 50% charge at 10<sup>16</sup>N<sub>eq</sub>/cm<sup>2</sup> at high bias voltages
- n-in-p benefits from charge multiplication (at high bias voltages)
- n-in-p (n-in-n) superior material for high radiation environments

### Conclusions



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- RD50 working across experiment boundaries on SE developing radiation-hard silicon detectors for e.g. the HL-LHC
- Large progress in understanding the effective doping concentration
- For high fluences, significant electric field exists even in undepleted region, resulting in higher signals
- Charge amplification observed on many sensors. CCE benefits from it, but open questions remain
  - The S/N ratio benefits too (mostly), but this may be an issue of the way we derive the noise
  - Can the extra signal be exploited to increase the radiation hardness?
  - Need to study long-term stability

## Recommendations



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- Disclaimer: some views may be biased
- Planar detectors do better than expected
  - P-type detectors reduce trapping effects and can operate partially depleted
  - Significant electric field exists in undepleted region
  - Charge multiplication gives extra signal
- HL-LHC Si detector recommendations:
- N-in-p (n-in-n) planar detectors
  - good enough for most regions, well understood, expect this to be the default material at HL-LHC
- 3D detectors
  - could add extra radiation hardness and facilitate operation at lower voltage if required for innermost HL-LHC tracking layer(s)
  - watch out for extra costs and risks
- Credits: Tony Affolder, Gianluigi Casse, Paula Collins, Doris Eckstein, Alexandra Junkes, Michael Köhler, Gregor Kramberger, Igor Mandic, Michael Moll, Ioana Pintilie